

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
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EPAS ID: PAT5657266

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	RELEASE OF SECURITY INTEREST

CONVEYING PARTY DATA

Name	Execution Date
MORGAN STANLEY SENIOR FUNDING INC.,	06/28/2019

RECEIVING PARTY DATA

Name:	CYPRESS SEMICONDUCTOR CORPORATION
Street Address:	198 CHAMPION COURT
City:	SAN JOSE
State/Country:	CALIFORNIA
Postal Code:	95134

PROPERTY NUMBERS Total: 21

Property Type	Number
Patent Number:	5326551
Application Number:	09659527
Application Number:	10858023
Application Number:	12962608
Application Number:	11027005
Application Number:	13287521
Application Number:	13894027
Application Number:	60476530
Application Number:	10859675
Application Number:	60976398
Application Number:	12239602
Application Number:	12075632
Application Number:	14319041
Application Number:	09511652
Application Number:	09798667
Application Number:	12636764
Application Number:	12354513
Application Number:	13154348
Application Number:	12044831
Application Number:	60906042

PATENT

Property Type	Number
Application Number:	60934664

CORRESPONDENCE DATA

Fax Number: (408)545-6911

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Email: patents@cypress.com, aaaf@cypress.com

Correspondent Name: CYPRESS SEMICONDUCTOR CORPORATION

Address Line 1: 198 CHAMPION COURT

Address Line 4: SAN JOSE, CALIFORNIA 95134

ATTORNEY DOCKET NUMBER:	RELEASEOFSECURITYINTEREST
NAME OF SUBMITTER:	KIN HUNG LAI
SIGNATURE:	/Kin Hung Lai/
DATE SIGNED:	08/07/2019

Total Attachments: 4

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PARTIAL RELEASE OF SECURITY INTEREST IN PATENTS

This PARTIAL RELEASE OF SECURITY INTEREST (this “**Release**”) is made and executed by Morgan Stanley Senior Funding, Inc., as collateral agent for the Secured Parties (as defined in the Pledge and Security Agreement referred to below) (the “**Collateral Agent**”), in favor of Cypress Semiconductor Corporation, a Delaware corporation, and Spansion LLC, a Delaware limited liability company (each a “**Grantor**” and collectively, the “**Grantors**”). Capitalized terms used but not defined herein shall have the meanings ascribed to such terms in the Pledge and Security Agreement.

A. Pursuant to that certain Amended and Restated Pledge and Security Agreement, dated March 12, 2015 (as further amended and/or restated, supplemented or otherwise modified from time to time, the “**Pledge and Security Agreement**”), as security for the prompt and complete payment and performance in full when due (whether at stated maturity, by required prepayment, declaration, acceleration, demand or otherwise, including the payment of amounts that would become due but for the operation of the automatic stay under Section 362(a) of the Bankruptcy Code) of all Secured Obligations, each Grantor pledged and granted to the Collateral Agent, for its benefit and for the benefit of the Secured Parties, a continuing security interest in and Lien of all of its right, title, and interest in, to and under the Collateral.

B. Collateral Agent recorded its security interest with the United States Patent and Trademark Office as follows:

<u>Debtor</u>	<u>Secured Party</u>	<u>Reel/Frame</u>	<u>Recordation Date</u>
Cypress Semiconductor Corporation	Morgan Stanley Senior Funding, Inc.	028863/0870	August 28, 2012
Cypress Semiconductor Corporation	Morgan Stanley Senior Funding, Inc.	031636/0105	November 14, 2013
(1) Cypress Semiconductor Corporation (2) Spansion LLC	Morgan Stanley Senior Funding, Inc.	035240/0429	March 21, 2015
Cypress Semiconductor Corporation	Morgan Stanley Senior Funding, Inc.	039676/0237	August 15, 2016

C. Grantors have requested that the Collateral Agent release its continuing security interest in and Lien on all of Cypress Semiconductor’s right, title and interest in, to and under the patents, and applications therefor, set forth on Exhibit A (the “**Specified IP**”).

D. The Collateral Agent agrees to release its continuing security interest in and Lien on all of each Grantor’s right, title and interest in, to and under the Specified IP.

NOW, THEREFORE, for valuable consideration received, by its execution of this Release, the Collateral Agent hereby irrevocably and unconditionally releases, without representation, warranty or recourse, its continuing security interest in and Lien on all of each Grantor’s right, title and interest in, to and under the Specified IP.


For the avoidance of doubt, the Collateral Agent continues to maintain its continuing security interest in and Lien on all of each Grantor's right, title and interest in, to and under all Collateral other than the Specified IP. The provisions of the Pledge and Security Agreement shall, except as modified by this Release, continue in full force and effect.

This Release is governed by the law of the State of New York, excluding its choice of law principles that would result in the application of any law other than the law of the State of New York. This Release shall be binding upon, and inure to the benefit of, each Grantor and their respective successors and assigns with respect to the Specified IP (including any purchaser thereof).

[Signature page follows]

IN WITNESS WHEREOF, the undersigned has executed this Partial Release of Security Interest in Patents on this 28th day of June 2019.

Morgan Stanley Senior Funding, Inc., as Collateral Agent

By:  _____

Name: Lisa Hanson

Title: Vice President

Exhibit A

Specified IP

Item No.	Case No.	Country	App #	Filing Date	Patent Number	Issue Date
1	CD00110	US	09/659,527	9/12/2000	6745338	6/1/2004
2	CD00110C1	US	10/858,023	6/1/2004	7080276	7/18/2006
3	CD04140C1	US	12/962,608	12/7/2010		
4	CD04140	US	11/027,005	12/30/2004	7848703	12/7/2010
5	CD04140C2	US	13/287,521	11/2/2011	8442437	5/14/2013
6	CD04140C3S	US	13/894,027	5/14/2013		
7	CD03055P1	US	60/476,530	6/4/2003		
8	CD03055	US	10/859,675	6/2/2004		
9	CD03055P2	US	60/976,398	9/28/2007		
10	CD03055CIP1	US	12/239,602	9/26/2008	8140013	3/20/2012
11	CD07058	US	12/075,632	3/12/2008	8769177	7/1/2014
12	CD07058C1	US	14/319,041	6/30/2014	9588916	3/7/2017
13	SPN00045	US	09/511,652	2/22/2000	6246610	6/12/2001
14	SPN01027	US	09/798,667	3/2/2001	6528390	3/4/2003
15	SPN08013CIP1	US	12/636,764	12/13/2009	8324873	12/4/2012
16	SPN08013	US	12/354,413	1/15/2009		
17	SPN08013JPD1	JP	2008-326685	12/23/2008	5326551	8/2/2013
18	CD07037C1	US	13/154,348	6/6/2011	8370543	2/5/2013
19	CD07037	US	12/044,831	3/7/2008	8145809	3/27/2012
20	CD07037P1	US	60/906,042	3/9/2007		
21	CD07037P2	US	60/934,664	6/14/2007		